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APPLICATION DATA SHEET

Application Information

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?: None

Number of CD disks::

Number of copies of CDs::

Sequence submission?:

Computer Readable Form (CRF)?:: No

Number of copies of CRF::

Title :: CONDUCTIVE PASTE FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT AND A METHOD FOR MANUFACTURING A MULTI-LAYERED UNIT FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT

Attorney Docket Number:: 890050.545USPC

Request for Early Publication?: No

Request for Non-Publication?: No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity?: No

Petition included?: No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No.:

Secrecy Order in Parent Appl.?: No

First Applicant Information

Applicant Authority Type: Inventor

Primary Citizenship Country: Japan

Status: Full Capacity

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Middle Name:

Family Name: Satou

Name Suffix:

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Second Applicant Information

Applicant Authority Type: Inventor

Primary Citizenship Country: Japan

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Correspondence Information

Correspondence Customer Number :: **00500**

Representative Information

Representative Customer Number::		00500
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2005/002882	02/23/05

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-054723	02/27/04	Yes

Assignee Information

Assignee name::	TDK Corporation
Street of mailing address::	1-13-1, Nihonbashi, Chuo-ku
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State or Province of mailing address::	
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Postal or Zip Code of mailing address::	103-8272

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